



50V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	Rds(ON) Max	I _D T _A = +25°C
	2Ω @ V _{GS} = 5V	410mA
50V	2.5Ω @ V _G S = 2.5V	370mA
	4Ω @ V _G S = 1.8V	290mA

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Load switches
- Level switches

Features and Benefits

- Low On-Resistance
- Very Low Gate Threshold Voltage (1.0V max)
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN52D0UDMQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SOT26
- Package Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.015 grams (Approximate)

SOT26

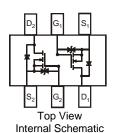








Bottom View



Ordering Information (Note 4)

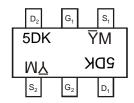
Part Number	Pankaga	Packing		
Part Number	Package	Qty.	Carrier	
DMN52D0UDMQ-7	SOT26	3000	Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



 $\underline{5}DK = Product Type Marking Code$ YM = Date Code Marking \overline{Y} = Year (ex: K = 2023) M = Month (ex: 6 = June)

Date Code Key

Year	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034
Code	K	L	М	N	Р	R	S	T	U	V	W	Х
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		VDSS	50	V	
Gate-Source Voltage	Vgss	±12	V		
Continuous Drain Current (Note 6) Vgs = 5V	Δ	410 260	mA		
Maximum Continuous Body Diode Forward Curr	ent (Note 6)	Is	410	mA	
Pulsed Drain Current (10µs Pulse, Duty Cycle =	1%)		I _{DM}	1.2	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	0.49	mW
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	256	°C/W
Total Power Dissipation (Note 6)		PD	0.74	mW
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	170	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Notes:

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

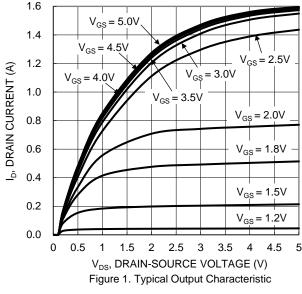
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						•
Drain-Source Breakdown Voltage	BVDSS	50	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	l	_	1	μΑ	V _{DS} = 50V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 12V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(th)	0.49	_	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
			1.5	4.0		$V_{GS} = 1.8V, I_{D} = 50mA$
Static Drain-Source On-Resistance	RDS(ON)		1.2	2.5	Ω	$V_{GS} = 2.5V, I_{D} = 50mA$
		_	0.95	2.0		$V_{GS} = 5.0V, I_{D} = 50mA$
Diode Forward Voltage	VsD	_	0.6	1.2	V	V _G S = 0V, I _D = 50mA
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		42.4	_	pF	
Output Capacitance	Coss		6.1	_	pF	V _{DS} = 25V, V _{GS} = 0V, -f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	2.8	_	pF	1 – 1.00012
Gate Resistance	R_g	ı	51.8	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (VGS = 4.5V)	Qg	ı	0.9	_	nC	
Total Gate Charge (VGS = 10V)	Qg	_	1.6	_	nC	\/ 25\/ I- 50m \
Gate-Source Charge	Qgs	_	0.2	_	nC	$V_{DS} = 25V, I_D = 50mA$
Gate-Drain Charge	Q_{gd}	_	0.2	_	nC	
Turn-On Delay Time	td(on)	_	1.3	_	ns	
Turn-On Rise Time	t _R	_	9.5	_	ns	$V_{DS} = 25V, V_{GS} = 10V,$
Turn-Off Delay Time	tD(OFF)	_	32	_	ns	$R_G = 50\Omega$, $I_D = 50mA$
Turn-Off Fall Time	tF	_	37.5	_	ns	

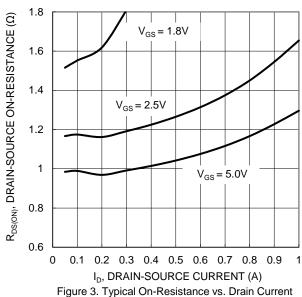
Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.









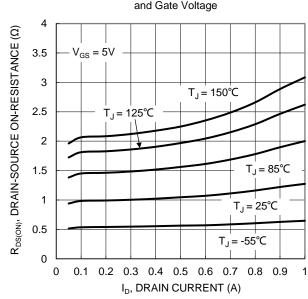
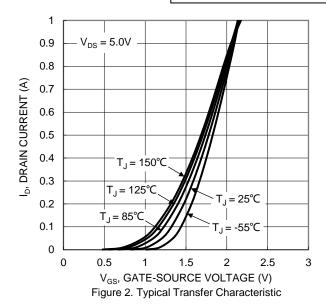
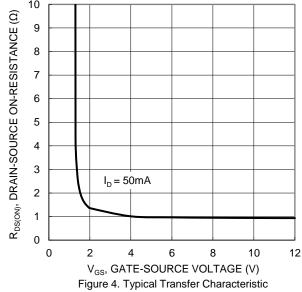


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





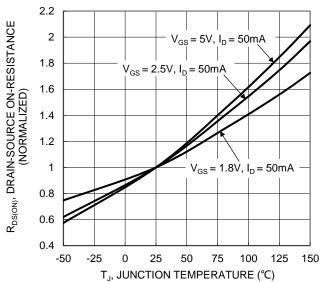


Figure 6. On-Resistance Variation with Junction Temperature





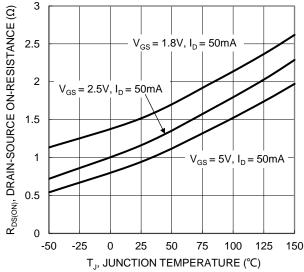
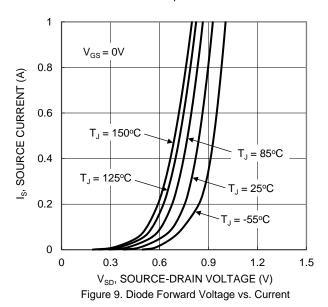


Figure 7. On-Resistance Variation with Junction Temperature



10 8 6 V_{GS} (V) 4 $= 25V, I_D = 50mA$ 2 0 0.5 0 1 2 1.5

 Q_{α} (nC) Figure 11. Gate Charge

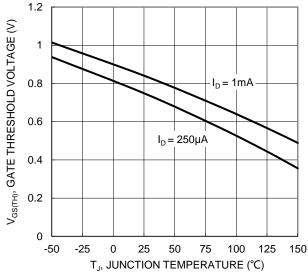


Figure 8. Gate Threshold Variation vs. Junction Temperature

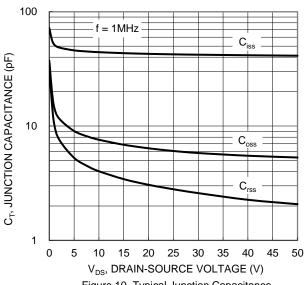


Figure 10. Typical Junction Capacitance

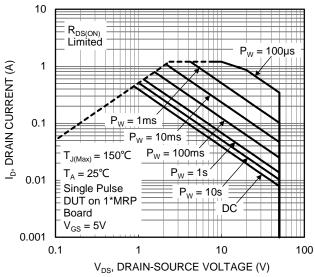


Figure 12. SOA, Safe Operation Area



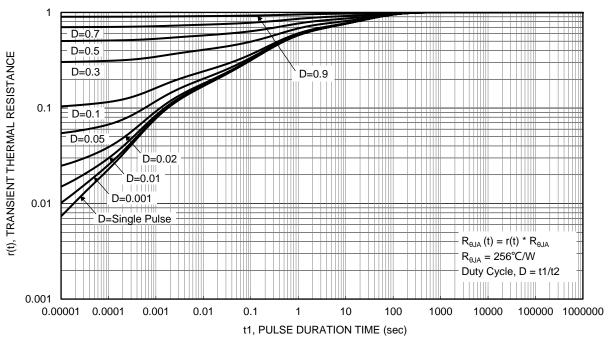
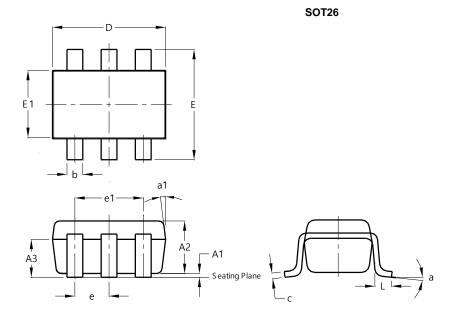


Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

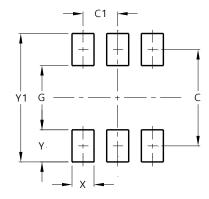


SOT26						
Dim	Min	Max	Тур			
A1	0.013	0.10	0.05			
A2	1.00	1.30	1.10			
A3	0.70	0.80	0.75			
b	0.35	0.50	0.38			
С	0.10	0.20	0.15			
D	2.90	3.10	3.00			
е	-	-	0.95			
e1	-	-	1.90			
Е	2.70	3.00	2.80			
E1	1.50	1.70	1.60			
L	0.35	0.55	0.40			
а	-	-	8°			
a1	-	-	7°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT26



Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Y	0.80
Y1	3.20



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